

WSR200N08

N-Ch MOSFET

General Description

The WSR200N08 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSR200N08 meet the RoHS and Green Product requirement,100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed •
- Green Device Available •

Product Summery

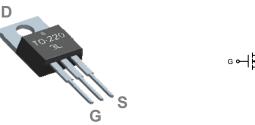
BV _{DSS}	R _{DSON}	I _D
80V	2.9mΩ	200A

Applications

Switching application

Power Management for Inverter Systems.

TO-220FB-3L Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	80	V
V _{GS}	Gate-Source Voltage	±25	V
I _D @T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	200	A
I _D @T _C =100℃	Continuous Drain Current, V _{GS} @ 10V ¹	144	A
I _{DM}	Pulsed Drain Current ²⁻ T _C =25°C	790	A
EAS	Avalanche Energy, Single pulse,L=0.5mH	1496	mJ
I _{AS}	Avalanche Current, Single pulse,L=0.5mH	200	A
P _D @T _C =25℃	Total Power Dissipation ⁴	345	W
P _D @T _C =100℃	Total Power Dissipation ⁴	173	W
T _{STG}	Storage Temperature Range	-55 to 175	°C
TJ	Operating Junction Temperature Range	175	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction-Ambient ¹		62.5	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		0.43	°C/W



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Electrical Characteristics (T_J=25 C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	80			V
$\triangle BV_{DSS} / \triangle T_J$	BV _{DSS} Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$, I_D = 1mA		0.096		V/℃
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V,I _D =100A		2.9	3.5	mΩ
V _{GS(th)}	Gate Threshold Voltage		2.0	3.0	4.0	V
V _{GS(th)}	V _{GS(th)} Temperature Coefficient	VGS-VDS; ID -2500A		-5.5		mV/℃
	Drain Source Lookage Current	$V_{\text{DS}}\text{=}80\text{V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}25^\circ\!\text{C}$			1	uA
I _{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}\text{=}80\text{V}$, $V_{\text{GS}}\text{=}0\text{V}$, $T_{\text{J}}\text{=}55^\circ\!\text{C}$			10	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm25V$, V_{DS} =0V			±100	nA
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		3.2		Ω
Qg	Total Gate Charge (10V)			197		
Q _{gs}	Gate-Source Charge	$V_{\text{DS}}\text{=}80V$, $V_{\text{GS}}\text{=}10V$, $I_{\text{D}}\text{=}30A$		31		nC
Q _{gd}	Gate-Drain Charge			75		
T _{d(on)}	Turn-On Delay Time			28		
Tr	Rise Time	V _{DD} =50V , V _{GS} =10V ,		18		
T _{d(off)}	Turn-Off Delay Time	R _G =3Ω, I _D =30A		42		ns
T _f	Fall Time			54		
C _{iss}	Input Capacitance			8154		
C _{oss}	Output Capacitance	ut Capacitance V _{DS} =15V , V _{GS} =0V , f=1MHz		1029		pF
C _{rss}	Reverse Transfer Capacitance			650		

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy 5	V _{DD} =25V , L=0.5mH , I _{AS} =28A	160			mJ

Diode Characteristics

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}				200	А
I _{SM}	Pulsed Source Current ^{2,6}	$V_G=V_D=0V$, Force Current			350	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =15A , TJ=25℃			1.2	V
t _{rr}	Reverse Recovery Time			30		nS
Qrr	Reverse Recovery Charge	IF=15A,dI/dt=100A/µs,TJ=25℃		52		nC

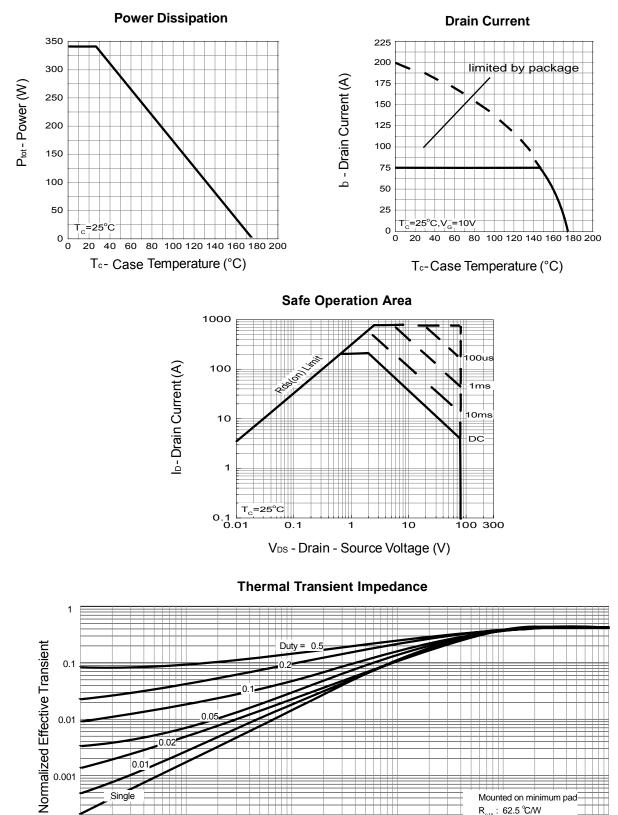
Note * : Pulse test ; pulse width \leq 300 μ s, duty cycle \leq 2%.



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Typical Operating Characteristics



0.0001 0.0001 Single

0.001

0.1

0.01

Square Wave Pulse Duration (sec)

10

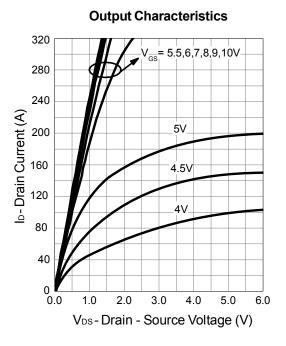
Mounted on minimum pad-R_{₀JA}: 62.5 ℃/W

1

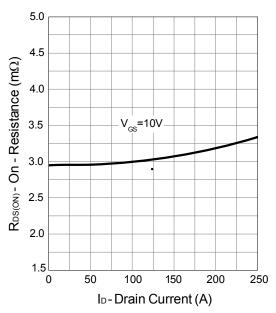


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Typical Operating Characteristics (Cont.)



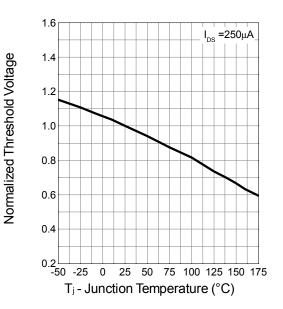
Drain-Source On Resistance



14 I_{DS}=100A 12 $R_{DS(ON)}$ - On - Resistance (m Ω) 10 8 6 4 2 0 ∟ 3 4 5 6 7 8 9 10 V_{GS} - Gate - Source Voltage (V)

Gate-Source On Resistance

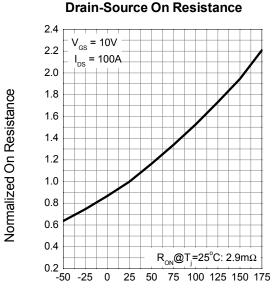
Gate Threshold Voltage





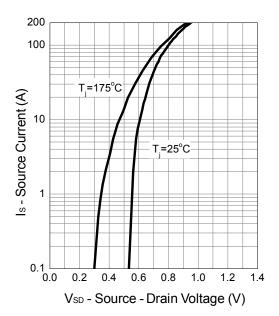
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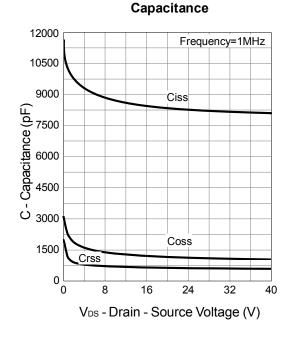
Typical Operating Characteristics (Cont.)



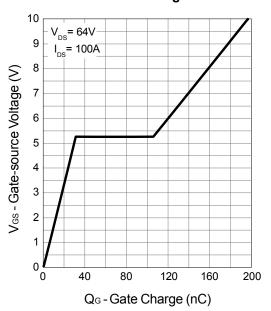
T_j-Junction Temperature (°C)

Source-Drain Diode Forward





Gate Charge



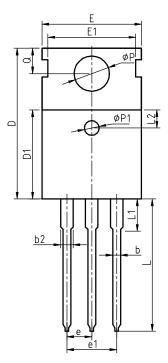


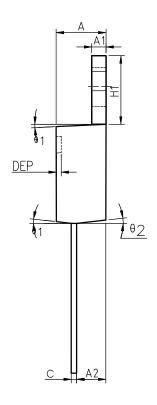
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N-Ch MOSFET

Package Information TO-220AB

TO-220FB-3L





COMMON DIMENSIONS

	I		
ΠΠ			
•	E2	-	

SYMBOL	MI N	NOM	MAX	MI N	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185
A1	1.27	1.30	1.33	0.050	0.051	0.052
A2	2.35	2.40	2.50	0.093	0.094	0.098
b	0.77	0.80	0.90	0.030	0.031	0.035
b2	1.17	1.27	1.36	0.046	0.050	0.054
С	0.48	0.50	0.56	0.019	0.020	0.022
D	15.40	15.60	15.80	0.606	0.614	0.622
D1	9.00	9.10	9.20	0.354	0.358	0.362
DEP	0.05	0.10	0.20	0.002	0.004	0.008
E	9.80	10.00	10.20	0.386	0.394	0.402
E1	-	8.70	-	-	0.343	-
E2	9.80	10.00	10.20	0.386	0.394	0.402
е		2.54	BSC		0.100	BSC
e1		5.08	BSC		0.200	BSC
H1	6.40	6.50	6.60	0.252	0.256	0.260
L	12.75	13.50	13.65	0.502	0.531	0.537
L1	-	3.10	3.30	-	0.122	0.130
L2		2.50	REF		0.098	REF
Р	3.50	3.60	3.63	0.138	0.142	0.143
P1	3.50	3.60	3.63	0.138	0.142	0.143
Q	2.73	2.80	2.87	0.107	0.110	0.113
θ 1	5°	7 °	9 °	5°	7 °	9°
θ2	1 °	3°	5°	1 °	3°	5°
θ3	1 °	3°	5°	1 °	3°	5°



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